



UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE
 United States Patent and Trademark Office
 Address: COMMISSIONER FOR PATENTS
 P.O. Box 1450
 Alexandria, Virginia 22313-1450
 www.uspto.gov



Bib Data Sheet

CONFIRMATION NO. 7576

SERIAL NUMBER 10/524,013	FILING DATE 02/08/2005 RULE	CLASS 438	GROUP ART UNIT 2823	ATTORNEY DOCKET NO. 0152-0703PUS1
-----------------------------	---------------------------------------	--------------	------------------------	---

APPLICANTS

Hisashi Yamada, Tsukuba, JAPAN;

Noboru Fukuhara, Tsukuba, JAPAN;

** CONTINUING DATA *****

This application is a 371 of PCT/JP03/09818 08/01/2003 *hfe*

** FOREIGN APPLICATIONS *****

JAPAN 2002-233708 08/09/2002 *hfe*

Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no	STATE OR COUNTRY JAPAN	SHEETS DRAWING 7	TOTAL CLAIMS 6	INDEPENDENT CLAIMS 3
35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after allowance	EXAMINER'S SIGNATURE <i>Michael J. Fodor</i>	INITIALS <i>hfe</i>		
Verified and Acknowledged				

ADDRESS

02292
 BIRCH STEWART KOLASCH & BIRCH
 PO BOX 747
 FALLS CHURCH, VA
 22040-0747

TITLE

Method for manufacturing compound semiconductor wafer and compound semiconductor device

FILING FEE	FEES: Authority has been given in Paper	<input type="checkbox"/> All Fees
RECEIVED 1260	No. _____ to charge/credit DEPOSIT ACCOUNT	<input type="checkbox"/> 1.16 Fees (Filing)
	No. _____ for following:	<input type="checkbox"/> 1.17 Fees (Processing Ext. of time)
		<input type="checkbox"/> 1.18 Fees (Issue)

	<input type="checkbox"/> Other _____
	<input type="checkbox"/> Credit _____